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Article

# Hydrophobic Surface Array Structure Based on Laser-Induced Graphene for Deicing and Anti-Icing Applications

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Abstract: The exceptional performance of graphene has driven the advancement of its preparation technique and application. Laser-induced graphene (LIG), as a novel graphene preparation technique, has been applied in various fields. Graphene periodic structures created by LIG technique exhibit superhydrophobic characteristics and can be used for deicing and anti-icing applications, which are significantly influenced by the laser parameters. The laser surface treatment process was simulated by a finite element software analysis (COMSOL Multiphysics) to optimize the scanning parameter range, and the linear array surface structure were subsequently fabricated by the LIG technique. The generation of graphene was confirmed by Raman spectroscopy, and energy-dispersive X-ray spectroscopy. The periodic linear array structure were observed by Scanning electron microscopy (SEM) and confocal laser imaging (CLSM). In addition, CLSM testings, contact angle measurements, and delayed icing experiments were systematically performed to investigate the effect of scanning speed on surface hydrophobicity. The results show that the high quality and uniform graphene can be achieved using the laser scanning speed of 125 mm/s. The periodic linear array structures can obviously increase the contact angle and suppress delayed icing. Furthermore, these structures have the enhanced ability of the electric heating deicing, which can reach 100°C and 240°C within 15 s and within 60 s under the DC voltage power supply ranging from 3 to 7 V, respectively. These results indicate that the LIG technique can be developed to provide an efficient, economical, and convenient approach for preparing graphene and the hydrophobic surface array structure based on LIG has considerable potential for deicing and anti-icing applications.

**Keywords:** Laser-induced graphene; periodic linear array; hydrophobic; electric heating deicing; anti-icing application

#### 1. Introduction

Graphene has a remarkable single-layer, two-dimensional (2D) honeycomb lattice structure interconnected by sp² hybridization. Currently, graphene is the thinnest and strongest substance available. Owing to its ultrahigh carrier migration rate (105 cm²/V·s), excellent mechanical properties (1 TPa), large theoretical specific surface area (2630 m²/g), extraordinary thermal conductivity (5 kW/m·K), and commendable chemical stability [1–3], graphene stands out among other materials. Various methods, such as pyrolysis repeated stripping [4], vapor deposition [5], reduced graphene oxidization [6], and SiC epitaxial growth [7] methods, have been employed to prepare graphene.

However, these conventional preparation methods suffer from issues such as low efficiency, complicated operation, uncontrollable quality, and strict and harsh conditions. The breakthrough occurred in 2014 when Jame et al. discovered the use of laser direct writing technology to directly obtain graphene on polyimide (PI) films [8]. Consequently, owing to its straightforward process, wide range of substrate options and lasers available for use, high-precision control capabilities, and several other advantages, laser-induced graphene (LIG) technology has emerged with great potential for efficient large-scale graphene preparation while promoting low-C and environmentally friendly development.

The LIG technology uses laser surface treatment to induce photothermal or photochemical reactions on material surface [9], thereby breaking the chemical bonds between C atoms and other elements in the substrate material and facilitating their recombination into graphene structures. Several scholars have employed this technology for realizing high-performance capacitors [10], batteries [11], sensors [12], water decomposition [13], optical components [14], photothermal conversion devices [15], thermal brakes [16], and medical applications [17]. Owing to their small spot diameters, lasers possess a unique advantage in constructing intricate structures. As a combination of laser and graphene manufacturing, the LIG technology offers lighter multifunctional hydrophobic surfaces compared to traditional silicone rubber or fluorosilane-based superhydrophobic surfaces [18-21]. Moreover, it is more environmentally friendly and has greater potential for costeffectiveness. Currently, this technology has advantages in preparing graphene-based superhydrophobic surfaces and expanding their application to areas such as anticoronavirus methods based on hydrophobic and Joule thermal properties [22]. In addition, the LIG technology leverages high-precision patterning and distinctive electrowetting characteristics to achieve directional water transport function [23]. Furthermore, micro-/nanostructure can be constructed to enhance the microfluidic mixing effect [24]. Based on the structure, conductivity, and wettability of LIG, biosensing and energy storage devices can be fabricated for multiplex open microfluidic environments [25]. However, various factors such as laser parameters (e.g., laser power [26], spot size [27], scanning speed [28]), substrate materials (e.g., PDMS [24], PI paper [29]), surface doping [30], and processing patterns (e.g., microcolumns [31], periodic linear arrays [32,33], grids [24]) have different degrees of influence on the LIG preparation process. The exploration of the inherent characteristics of LIG and further development of its application value are essential for sustainable development. Therefore, employing the finite element software to simulate laser surface treatment and establishing the simulation results as the foundation for preparation and design represents an economically and environmentally effective approach [34].

Herein, LIG preparation was investigated using finite element software analysis. A multiphysics coupling model of the commonly used PI film under laser surface treatment was established using COMSOL Multiphysics software. The classical periodic linear array structure was used as the processing pattern. The effect of laser scanning speed on the surface heat accumulation and thermal stress in laser-induced PI films was analyzed and discussed. Based on the simulation analysis results, experimental preparation was performed, which verified the consistency between actual observations and simulated outcomes. Moreover, particular emphasis was placed on studying the effects of different laser scanning speeds on the surface morphology and quality of graphene. The prepared periodic linear array graphene exhibited variations in surface roughness, water contact angle (WCA), hydrophobicity, and delayed icing performance under various scanning speeds. In addition, the application of Joule thermal expansion revealed the broad potential application of the LIG technology in microstructure array construction, hydrophobic anti-icing, and electric deicing.

# 2. Experimental Process

### 2.1. Materials

In this experiment, a 125- $\mu$ m-thick PI film (DuPont Kapton HN) measuring 150 mm  $\times$  150 mm is utilized as the substrate for laser processing. Laser surface treatment is performed using a 10.6- $\mu$ m continuous CO<sub>2</sub> laser (SYNRAD P-150, Synrad, Inc., USA) at a 20-kHz frequency. Before laser

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processing, an ultrasonic cleaning machine (CR-010S, Shenzhen Chunlin Cleaning Equipment Co LTD, CHN) using distilled water and an air blast thermostat (DHG-202, Shaoxing Subo Instrument Co LTD, CHN) are employed for sample cleaning (30 min) and drying (40 min), respectively. Laser output power is measured and calibrated using an optical power meter (BIM-7614-0250F, Hangzhou Boyuan Optoelectronics Technology Co. Ltd., CHN). Subsequently, a laser control system comprising a vibroscope and parameter setting software called Marking Mate is used for film load adjustment and defocusing of the laser spot on a 3-axis mobile platform. The preparation process as shown in Figure 1.

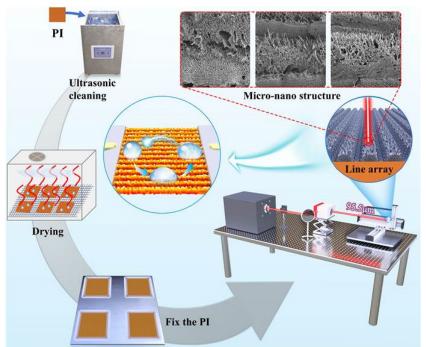


Figure 1. Preparation flow chart of LIG hydrophobic surface.

#### 2.2. Characterization equipment

A focused ion beam–scanning electron microscope (FIB-SEM, Thermo Scientific Helios 5 CX, USA) was used to observe surface micromorphology and perform surface scanning energy-dispersive X-ray spectroscopy (EDX). The degrees of surface carbonization and structural defects were measured using a laser confocal Raman spectrometer (Renishaw inVia, UK) with a laser light source at 532-nm wavelength. The microscopic morphology of a 1415  $\mu m \times 1061~\mu m$  surface area was observed via three-dimensional (3D) confocal laser scanning microscopy (CLSM, Keyence VK-X1000, Japan). A contact angle tester (Kruss DSA100, GER) and the accompanying ADVANCE interface analysis software were used to observe the state of water droplets on the graphene surface. The surface resistance of graphene was measured using a four-probe tester (RTS-8, Guangzhou four-probe technology instrument Co., LTD, CHN), and the average value of the nine randomly measured points was considered as the resistance value. The electric Joule thermal properties of the graphene surface were stabilized using a linear DC power supply (RIGOL DP700, CHN), and the surface heating infrared images were collected using an infrared thermal imager (Fluke TiX650, USA). Industrial optical lens electron microscopy (TDR 48MP FHD Camera V8, CHN) was employed to observe the freezing state of water droplets on the graphene surface.

# 2.3. Simulation parameters

First, we developed a physical model of a PI substrate with dimensions of 1.5 cm  $\times$  1.5 cm  $\times$  125  $\mu$ m (L  $\times$  D  $\times$  H) using the geometry module of COMSOL Multiphysics software based on the laser processing pattern size (1 cm  $\times$  1 cm) and PI film thickness. To simulate the laser action, we modeled

the laser beam as a Gaussian distribution on the XY interface and expressed the light intensity distribution on each horizontal interface along the optical path as follows [35]:

$$I(\mathbf{r}) = I_0 e^{-2r^2/\omega^2} = \frac{2P}{\pi R^2} e^{-2r^2/R^2}$$
 (1)

where *P* represents the laser power, *r* represents the distance from any point in the spot plane to the spot center, and *R* represents the radius of the laser to the spot in the plane.

According to Equation (1), a moving heat source was established by combining triangular wave and piecewise functions to simulate the effect of actual laser processing on the film surface. The temperature field on positive and negative film substrate surfaces and the temperature-induced thermal stress and temperature and stress changes during scanning at the positive/back spot of films were monitored and recorded using a boundary probe. Solid heat transfer physical field was designed to facilitate the absorption, diffusion, and radiation of temperature from the moving heat source [35,36]. The thermal diffusion conduction for a material is expressed as follows:

$$\rho C_{p} \frac{\partial T}{\partial t} + \rho C_{p} v \cdot \nabla T + \nabla \cdot (-k \nabla T) = Q + Q_{T}$$
(2)

where  $\rho$  represents the material density,  $C_p$  represents the constant pressure heat capacity of the material, T represents the temperature, v represents the velocity vector, k represents the thermal conductivity of the material, Q represents the heat absorbed by the material, and  $Q^T$  represents the thermoelastic damping of the material.

The conversion of laser energy absorbed by a film into heat is determined by the absorption and reflection of light on its surface during laser action; this is described as follows:

$$-n \cdot q = I_0 \cdot \theta \, , \tag{3}$$

where  $I_0$  represents the laser energy and  $\theta$  represents the light energy conversion efficiency of the material ( $\theta$  = 0.1778) [37].

A simulation was performed to analyze the thermal stress process occurring on the PI thin film surface. The back of the PI thin film was fixed as a constraint while the remaining surface was free. The calculation formula for thermal strain is expressed as follows:

$$\varepsilon_{\rm th} = \alpha(T)(T - T_{\rm ref}) \tag{4}$$

where  $\varepsilon_{th}$  represents thermal strain,  $\alpha$  represents the coefficient of thermal expansion, T represents the film surface temperature, and  $T_{ref}$  represents the volume reference temperature.

The relevant parameters of the PI thin film were set in accordance with the Kapton HN series data books and related literature [38,39].

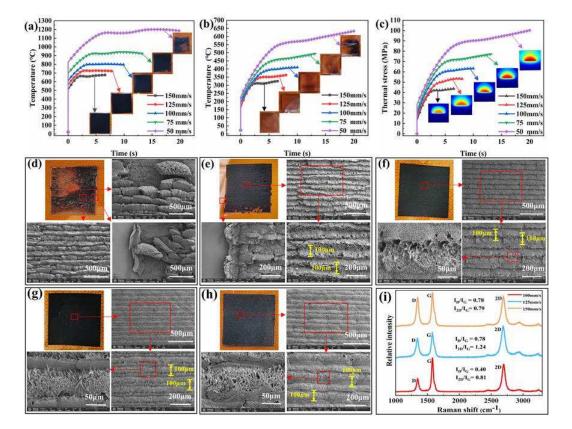
# 3. Results and Discussion

# 3.1. Simulation analysis and characterizations

The simulation results of temperature and heat strain, which are obtained from the multiphysics field coupling model, are shown in Figure 2. a–c. Figure 2a shows that an increase in scanning speed while keeping other laser parameters constant leads to a decrease in the steady-state temperature on the film surface. This observation agrees with the fundamental principles governing rapid heat accumulation during laser scanning. The simulation results in Figure 2c show the thermal stress exerted on the back of the PI film. The 3% yield point stress, which is ~61 MPa for the PI film, indicates that when the scanning speed is <100 mm/s, the thermal stress applied to the back of the film will exceed its threshold and result in folding. These findings agree with the actual observations depicted in Figure 2b. Furthermore, a consistent agreement exists between our finite element model and real

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laser effects, indicating that strategic use of our model can offer valuable insights for experimental purposes.



**Figure 2.** (a–c) Finite element simulation results of the PI surface directly written using a CO<sub>2</sub> laser between temperature trend and surface treatment time: positive temperature, negative temperature, and heat stress. (d–h) SEM images of LIG arrays at scanning speeds of 50, 75, 100, 125, and 150 mm/s, scale bar:  $500 \mu m$ ,  $200 \mu m$ ,  $50 \mu m$ ;. (i) Raman spectra of the LIG array surface at scanning speeds of 100, 125, and  $150 \mu m$ .

The microstructure of the thin film surface was observed after postlaser treatment. The SEM images in Figure 2.d-h display the graphene surface at a scanning speed range 50-150 mm/s (with a 25-mm/s spacing interval). The linear array formed via laser scanning is distinctly visible, albeit with variations in the microstructure within the linear array. At a 50-mm/s scanning speed, several shed and defective structures can be observed on the linear array surface, with certain areas exhibiting overlap between track paths. These phenomena are attributable to the excessively low scanning speed, in which causes excessive temperature accumulation around each spot and graphene generation area to exceed its designated size, thereby leading to track overlap. In addition, excessive thermal stress on the film surface induces a decrease in adhesion performance for surface products, resulting in detachment. In addition, a 75-mm/s scanning speed resulted in surface product and microstructure deteriorations, which are attributed to excessive heat accumulation. However, compared with the 50-mm/s scanning speed, there is a reduction in the deterioration regions and overlap rate of linear array trajectory, indicating an improvement achieved due to the increased scanning speed. The linear array surface exhibited consistent coverage but contained considerable amount of voids caused by gas precipitation. At the scanning speeds of 100-150 mm/s, the surface exhibited a uniform linear array structure with gaps between tracks. At the 100-mm/s scanning speed, rough burr structures filled up these gaps, whereas at 125-mm/s scanning speed, fine and medium holes and sheet burrs occupied them, forming the trajectory with decreasing density of large hole defects. At 150-mm/s scanning speed, fused PI filled up these gaps and mesoporous and microburr

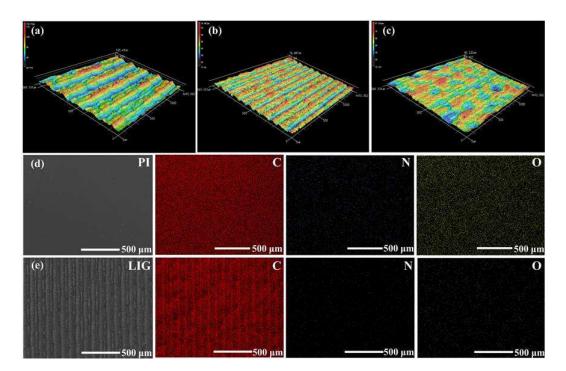
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structures formed the trajectory accompanied by scattered large pore defects whose appearance is related to the thermal decomposition degree of deep-layer PI films.

The composition and microscopic binding structure of the linear array structure were further analyzed and investigated using Raman spectroscopy, laser confocal imaging, and EDS elemental analysis on surfaces with reduced defects at scanning speeds of 100, 125, and 150 mm/s (Figures 2i and 3). Raman spectra were examined to identify the characteristic peaks associated with graphene: D, G, and 2D peaks at approximately 1345.9, 1577.9, and 2692.6 cm<sup>-1</sup> for the three scanning speeds. The ratios between these peaks were analyzed to explain their distinctive features. The linear array surface with a scanning speed of 100 mm/s exhibited an I<sub>D</sub>/I<sub>G</sub> ratio of 0.4 and an I<sub>2D</sub>/I<sub>G</sub> ratio of 0.81, where the lower ID/IG ratio reflected a reduced presence of defect structures compared with smoother SEM images previously observed. For the linear array surface with a scanning speed of 125 mm/s, an Ip/I<sub>G</sub> ratio of 0.78 was observed along with an I<sub>2D</sub>/I<sub>G</sub> ratio of 1.24, indicating an increased defect distribution as reflected by the higher Ip/IG ratio and suggesting a tendency toward single-layer C structure due to the elevated I2D/IG ratio. Meanwhile, for the linear array surface with a scanning speed of 150 mm/s, the I<sub>D</sub>/I<sub>G</sub> (0.78) and I<sub>2D</sub>/I<sub>G</sub> (0.79) ratios remained relatively unchanged because of the rough burr structure present between the gaps in the linear array. The lower I2D/IG ratio is attributed to varying degrees of carbonization in multilayer PI films due to lower scanning speed[40]. In summary, graphene quality was superior at the scanning speeds of 100 and 125 mm/s.

The surface geometry of the graphene linear array is shown in Figure 2a–c. Decreasing the laser scanning speed increases protrusions along the linear array, while the gullies represent the gaps between laser tracks. The scanning speed of 100 mm/s generated a rectangular microrough gully structure with a consistent height of ~120  $\mu$ m. At the scanning speed of 125 mm/s, evenly distributed trapezoidal gullies were observed within the linear array, exhibiting a height of ~75  $\mu$ m and a protruding width of ~100  $\mu$ m, which is consistent with the SEM measurements. Gradually increasing the scanning speed to 150 mm/s introduced discrete bumps along the graphene linear array surface, characterized by relatively dispersed heights ranging from 60 to 80  $\mu$ m. This phenomenon is attributed to the uneven heat accumulation due to high scanning speeds.

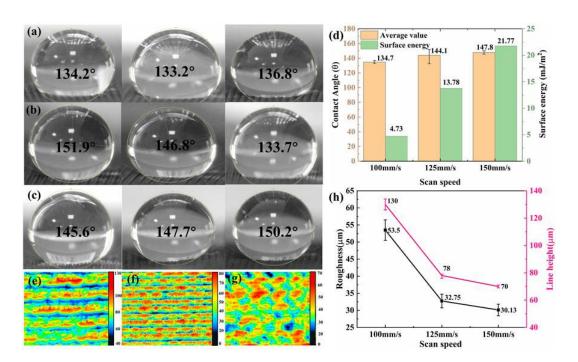
Analyzing the SEM images, Raman spectral characteristics, and laser confocal imaging data revealed that the surface quality and uniformity for graphene generation reach their optimum at a scanning speed of 125 mm/s. To further validate the effect of the laser treatment on increasing C content while minimizing other major elements, EDS analysis was performed on the PI film and surface prepared at a scanning speed of 125 mm/s. The EDS elemental mapping images for C, N, and O are shown in Figure 3d–e. Comparing the C distribution between the two samples revealed that laser processing considerably enhanced the C content on the surface. In addition, within each scanned locus by the center spots of the laser beam lies a higher C concentration because of the complete thermal decomposition due to the high energy at this region. Moreover, a noticeable reduction in N and O was observed on the graphene linear array surface compared with those present in the PI film. This observation agrees with the LIG formation mechanism under photothermal effects.



**Figure 3.** (a–c) CLSM test diagram of the graphene linear array surface at scanning speeds of 100, 125, and 150mm/s. (d–e) EDS test diagram of the graphene linear array surface on PI film at a scanning speed of 125 mm/s, scale bar:  $500 \, \mu m$ .

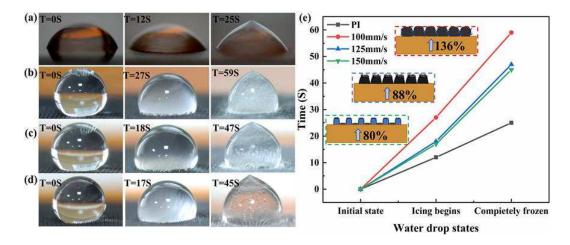
# 3.2. Surface hydrophobic properties and delayed icing effect

The linear array structure with a specific height exhibited remarkable hydrophobicity and potential. Consequently, the WCA and surface energy of the linear array surface prepared at 100-, 125-, and 150-mm/s scanning speeds were subjected to testing. The WCA and surface energy were randomly measured thrice, and the average values were considered as the final results. The results are shown in Figure 4a–d. A slight increase in the WCA was observed with an increase in scanning speed. Nevertheless, all samples displayed exceptional hydrophobicity (CA =  $134.7^{\circ}$ – $147.8^{\circ}$ ). Notably, there was a considerable increase in the overall surface energy from 4.73 to 21.77 mJ/m², which consequently enhanced the water droplet adhesion on the surface.



To further investigate the effect of laser scanning speed on contact angle and surface wetting characteristics, we performed tests on the 2D height and roughness of the graphene linear array at three scanning speeds (Figure 4e–h). The top-down structure revealed in the 2D height map demonstrated a considerable degree of consistency with features observed in the laser confocal 3D image analysis. Using the Gwyddion software for processing the 2D height map enabled us to obtain measurements for roughness and line height across all three surface structures. An increase in scanning speed decreased the convex height for the graphene linear array. Furthermore, SEM microscopic images indicated a reduction in surface irregularities and burr structures, resulting in a considerable decrease in roughness from 53.4 to 30.13 µm. This trend was also reflected by changes in line height. The decrease in roughness further enhanced the liquid–solid contact region, which resulted in compromised surface anti-wetting properties and increased surface energy, thereby enhancing droplet adhesion.

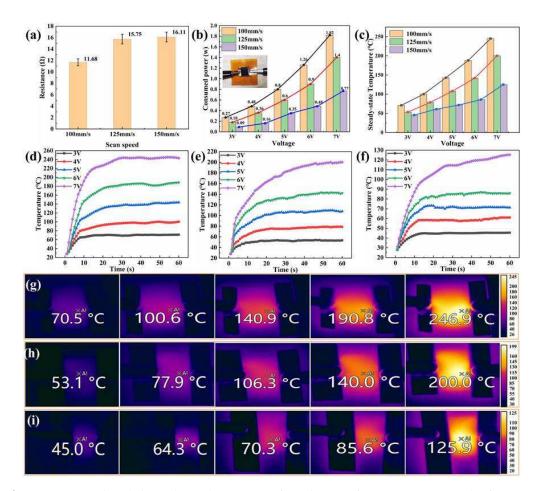
Based on the analysis of the aforementioned basic test results, the delayed icing effect of the graphene linear array surface prepared under the three scanning speeds was examined, and the results are shown in Figure 5a-d. Owing to the periodic convex and concave structure of the graphene linear array surface, it forms a gully-like topography that effectively reduces the contact region between the droplets and surface. This structure feature facilitates air pocket formation between the droplets and surface, thereby reducing the temperature diffusion rate and serving as a heat insulation buffer during temperature fluctuations on the linear array surface. To observe this delayed icing effect, it was affixed onto a small cooling plane maintained at a stable temperature of -23°C to minimize the heat transfer from beneath to droplets. The ice nuclei began forming on the PI film at *t* = 12 s, with complete freezing occurring at t = 25 s. Moreover, the tested graphene linear array surface exhibited varying degrees of delayed icing effects when subjected to scanning speeds of 100, 125, and 150 mm/s. To visually and more effectively compare these effects, time was considered as an evaluative scale with point plots representing the initial state (not ice), onset state (ice nuclei appearance), and complete icing state (Figure 5e). The surface revealed a subtle enhancement effect on the appearance of delayed ice nuclei, whereas it considerably improved the performance of the delayed complete icing of droplets. Based on the aforementioned observations on surface microstructure, a diagram depicting the delayed complete icing effect resulting from different surface morphology structures is shown in Figure 5e. When the scanning speed was set to 100 mm/s, cavitation was more likely to occur at the liquid-solid contact interface due to the presence of intricate perforations in the linear array track and burr structure within gaps. In addition, the heightened graphene elevations weakened the bond between frozen droplets and embedded microstructures on the liquid-solid contact surface, resulting in a 136% increased delay effect. At the scanning speed of 125 mm/s, burrs were formed on the array surface while smoother pores constituted gaps. Nevertheless, some degree of cavitation could still be achieved.



**Figure 5.** Schematic and mechanism of delayed icing effect on graphene linear array surface at low temperatures: (a–d) The corresponding time of the initial state of the droplet on the surface and the beginning of ice core and complete icing at scanning speeds of 100, 125, and 150 mm/s; (e) Comparison of delayed icing effect and delayed icing mechanism in terms of time.

#### 3.3. Electrothermal properties and deicing effect

Owing to the presence of a C conductive region on the linear graphene array surface, tests were performed to evaluate surface resistance, power consumption, and Joule thermal performance. Surface resistance was determined using a four-probe tester to measure the block resistance at nine points and calculate an average value (Figure 6a). Lower scanning speeds facilitated a more thorough decomposition of elements within the PI film, resulting in graphene with reduced surface resistance. A Cu foil was connected at both ends of the linear array to assess the connection resistance and electric Joule thermal performance, and the results are shown in Figure 6b-c. A decrease in surface resistance increased the power consumption and electric Joule thermal performance. The power consumption rule for the graphene surface follows the electric power calculation formula  $P = U^2/R$ . Notably, with a DC voltage power supply ranging from 3 to 7 V, the minimum power consumption reached 0.09 W while the maximum power consumption was only 1.82 W. Figure 6d-f show the temperature change trend of the graphene surface, highlighting its exceptional responsiveness to heat and remarkable energy conversion efficiency. Within just 15 s, the surface temperature can rapidly increase to 100°C, and within just 60 s, it can even reach a considerably high temperature of 240°C. As shown in Figure 6g-i, the precise temperature regulation within the range 70°C-240°C can be achieved by adjusting scanning speeds. In particular, a scanning speed of 100 mm/s enabled the accurate temperature control. Similarly, scanning speeds of 125 and 150 mm/s facilitated the accurate temperature regulation within ranges 50°C-200°C and 45°C-125°C, respectively. These flexible and controllable thermal adjustment capabilities and hydrophobicity are indispensable for anti-icing and electrothermal deicing technologies.



**Figure 6.** Laser-induced electrothermal properties of graphene surface at scanning speeds of 100, 125, and 150 mm/s: (a) Square resistance of graphene linear array surface; (b) Electrothermal connection method and power consumption of graphene surface; (c) Electrothermal steady-state temperature at a voltage of 3–7 V; (d–f) Trend chart of electric heating temperature change on the surface at different voltage values; (g–i) Infrared thermal imaging map corresponding to the surface electrothermal steady-state temperature.

# 4. Conclusions

In this study, COMSOL Multiphysics was employed to develop a simulation model of temperature and stress coupling on a PI thin film surface under laser surface treatment. Experiments were performed with reference to the simulation results. The graphene state on the positive surface of the PI thin film and the fold on the back of the film were consistent with those predicted by the simulation model. Using SEM, the microscopic effects of laser scanning speed on the surface morphology of graphene were investigated. The observations revealed that the microstructure changed from burnt paste shedding to uniform distribution of pores before developing into microburr shapes of pores. Raman spectroscopy tests performed on the surfaces with more regular graphene morphology at scanning speeds of 100, 125, and 150 mm/s revealed that superior quality graphene was generated at scanning speeds of 100 and 150 mm/s. In addition, higher scanning speeds were not conducive for meeting the quality requirements of graphene generation. EDS tests were performed on the graphene linear array surface at a scanning speed of 125 mm/s, yielding excellent quality results that confirmed the reduction in N and O and other element content due to gas precipitation. Based on the findings from CLSM testing, contact angle measurements, surface energy analysis, roughness evaluation, and delayed icing experiments were systematically performed to investigate the effect of scanning speed on surface structure. Consequently, an enhanced contact angle and a suppressive effect on delayed icing were observed. Thus, this research expands upon the electric heating functionality of the graphene linear array surface because it can reach 100°C within 15 s or even 240°C within 60 s under a DC voltage power supply ranging from 3 to 7 V. These findings

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provide an effective approach for manufacturing low-cost, precision-controllable components that have hydrophobic, anti-icing, and deicing capabilities and electric heating properties.

**Author Contributions:** Conceptualization, methodology, software, validation, visualization, data curation, and writing-original draft, M.Z. and S.L.; Visualization, data curation, software and methodology, Y.Z. and H.F.; Resources, formal analysis and investigation, Y.J.; Data curation, visualization and funding acquisition, C.Q.; Methodology, supervision and writing-review & editing, J.L.; Data curation, resources, supervision, writing-review & editing and funding acquisition, L.Y.; All authors have read and agreed to the published version of the manuscript.

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